

Listing of USA patents and publications for Inventor J.A.A.M. Tourné, note that some of the patents can be outside the field of electronics. PCT patents are not shown in this summary. Patents in cooperation with other companies are not shown either.

Note that the list is not in chronological order.

Date: March 8, 2026.

Result #	Document/Patent number	Display	Title	Inventor name	Publication date	Pages
1	US-20240335979-A1	PDF Text	METHODS AND SYSTEMS FOR CUTTING A CHANNEL IN A PRECAST CONCRETE SLAB	Tourne; J.A.A.M.	2024-10-10	12
2	US-11690177-B2	PDF Text	Methods and systems for back-drilling a multi-layer circuit board	Tourne; J.A.A.M.	2023-06-27	12
3	US-20220304153-A1	PDF Text	METHOD FOR PRODUCING A PRINTED CIRCUIT BOARD	Tourne; J.A.A.M.	2022-09-22	52
4	US-11357105-B2	PDF Text	Method for producing a printed circuit board	Tourne; J. A. A. M.	2022-06-07	54
5	US-20220088825-A1	PDF Text	SYSTEM AND METHOD OF PROCESSING HOLLOW CORE ELEMENT WITH INTEGRATED WELDING PLATES	Vallgren; Sven et al.	2022-03-24	16
6	US-20210315103-A1	PDF Text	METHODS AND SYSTEMS FOR BACK-DRILLING A MULTI-LAYER CIRCUIT BOARD	Tourne; J.A.A.M.	2021-10-07	12
7	US-10368446-B2	PDF Text	Method for producing a printed circuit board	Tourne; J.A.A.M.	2019-07-30	36
8	US-20180054892-A1	PDF Text	METHOD FOR PRODUCING A PRINTED CIRCUIT BOARD	Tourne; J.A.A.M.	2018-02-22	53

Result #	Document/Patent number	Display	Title	Inventor name	Publication date	Pages
9	US-20170188466-A1	PDF Text	Method for Producing a Printed Circuit Board	Tourne; J.A.A.M.	2017-06-29	34
10	US-9603255-B2	PDF Text	Method for producing a printed circuit board	Tourne; J. A. A. M.	2017-03-21	35
11	US-20160249458-A1	PDF Text	Method for Producing a Printed Circuit Board	Tourne; J.A.A.M.	2016-08-25	33
12	US-20090233461-A1	PDF Text	Method of Manufacturing a Printed Circuit Board	Tourne; Joseph A. A. M.	2009-09-17	13
13	US-7428364-B2	PDF Text	Bending an optical fiber into a backplane	Tourne; Joseph A.A.M.	2008-09-23	6
14	US-20080127484-A1	PDF Text	Selective filling of through holes	Tourne; Joseph A.A.M.	2008-06-05	9
15	US-7364366-B2	PDF Text	Circuit board assembly having a guide insert	Tourne; Joseph A. A. M.	2008-04-29	6
16	US-20070172177-A1	PDF Text	Fiber optic circuit connector	Tourne; Joseph A.A.M.	2007-07-26	14
17	US-20070154160-A1	PDF Text	Bending an optical fiber into a backplane	Tourne; Joseph A.A.M.	2007-07-05	5

Result #	Document/Patent number	Display	Title	Inventor name	Publication date	Pages
18	US-20070143995-A1	PDF Text	Circuit board having a multi-signal via	Tourne; Joseph A.A.M. et al.	2007-06-28	18
19	US-20070089292-A1	PDF Text	Circuit board having a backdrilled multi-signal via	Tourne; Joseph A.A.M. et al.	2007-04-26	20
20	US-20070089902-A1	PDF Text	Circuit board having a multi-signal via	Tourne; Joseph A.A.M. et al.	2007-04-26	18
21	US-7187839-B2	PDF Text	Bending an optical fiber into a backplane	Tourne; Joseph A. A. M.	2007-03-06	6
22	US-7178994-B2	PDF Text	Fiber optic circuit connector	Tourne; Joseph A. A. M.	2007-02-20	14
23	US-20060278429-A1	PDF Text	Closed loop backdrilling system	Tourne; Joseph A.A.M. et al.	2006-12-14	12
24	US-20060275011-A1	PDF Text	Bending an optical fiber into a backplane	Tourne; Joseph A.A.M.	2006-12-07	5
25	US-20060215965-A1	PDF Text	Circuit board assembly having a guide insert	Tourne; Joseph A.A.M.	2006-09-28	6

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26	US-7096555-B2	PDF Text	Closed loop backdrilling system	Tourne; Joseph A. A. M. et al.	2006-08-29	14
27	US-7095939-B2	PDF Text	Bending an optical fiber into a backplane	Tourne; Joseph A.A.M.	2006-08-22	5
28	US-20060165345-A1	PDF Text	System and method for integrating optical layers in a PCB for inter-board communications	Tourne'; Joseph A.A.M.	2006-07-27	12
29	US-20060133741-A1	PDF Text	BENDING AN OPTICAL FIBER INTO A BACKPLANE	Tourne; Joseph A.A.M.	2006-06-22	6
30	US-20060098914-A1	PDF Text	Fiber optic circuit connector	Tourne; Joseph A.A.M.	2006-05-11	14
31	US-7024086-B2	PDF Text	System and method for integrating optical layers in a PCB for inter-board communications	Tourne; Joseph A. A. M.	2006-04-04	12
32	US-6976793-B2	PDF Text	Fiber optic circuit connector	Tourne; Joseph A. A. M.	2005-12-20	14
33	US-20050129349-A1	PDF Text	System and method for integrating optical layers in a PCB for inter-board communications	Tourne, Joseph A.A.M.	2005-06-16	13
34	US-20050128672-A1	PDF Text	Closed loop backdrilling system	Tourne, Joseph A.A.M. et al.	2005-06-16	14

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35	US-20050025446-A1	PDF Text	Bending an optical fiber into backplane	Tourne, Joseph A.A.M.	2005-02-03	5
36	US-6848840-B2	PDF Text	Fiber optic circuit board connector	Tourne; Joseph A. A. M.	2005-02-01	14
37	US-6834131-B2	PDF Text	System and method for integrating optical layers in a PCB for inter-board communications	Tourne; Joseph A. A. M.	2004-12-21	12
38	US-20040197054-A1	PDF Text	Fiber optic circuit connector	Tourne, Joseph A.A.M.	2004-10-07	14
39	US-6782181-B2	PDF Text	Bending an optical fiber into backplane	Tourne; Joseph A. A. M.	2004-08-24	6
40	US-20040008964-A1	PDF Text	Bending an optical fiber into backplane	Tourne, Joseph A.A.M.	2004-01-15	7
41	US-20030208740-A1	PDF Text	System and method for monitoring and improving dimensional stability and registration accuracy of multi-layer PCB manufacture	Tourne, Joseph A.A.M. et al.	2003-11-06	12
42	US-6594435-B2	PDF Text	Bending an optical fiber into a backplane	Tourne; Joseph A. A. M.	2003-07-15	7

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#	number	Display	Title	Inventor name	date	Pages
43	US-6581202-B1	PDF Text	System and method for monitoring and improving dimensional stability and registration accuracy of multi-layer PCB manufacture	Tourne ; Joseph A. A. M. et al.	2003-06-17	14
44	US-20030006068-A1	PDF Text	System and method for integrating optical layers in a PCB for inter-board communications	Tourne, Joseph A.A.M.	2003-01-09	13
45	US-20020197046-A1	PDF Text	Bending an optical fiber into a backplane	Tourne, Joseph A. A. M.	2002-12-26	7
46	US-20020176671-A1	PDF Text	Fiber optic circuit board connector	Tourne, Joseph A.A.M.	2002-11-28	14
47	US-6750404-B1	PDF Text	High density printed wiring board having in-via surface mounting, pads	Anslow; Philip Andrew et al.	2004-06-15	11